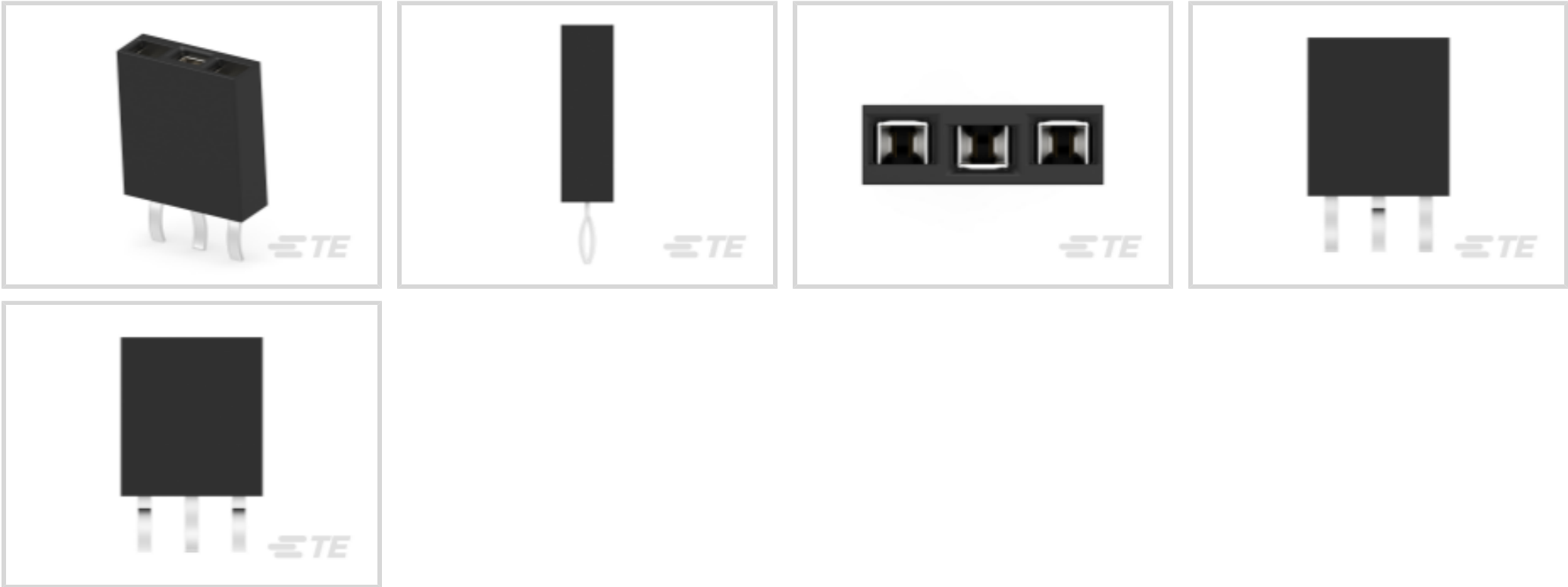




Connectors > PCB Connectors > PCB Headers & Receptacles



PCB Connector Type: **PCB Mount Receptacle**

PCB Mount Orientation: **Vertical**

Connector System: **Board-to-Board**

Number of Positions: **3**

Number of Rows: **1**

Features

Product Type Features

PCB Connector Type	PCB Mount Receptacle
Connector System	Board-to-Board
Header Type	Fully Shrouded
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
Connector Product Type	Connector Assembly

Configuration Features

Stackable	Yes
PCB Mount Orientation	Vertical
Number of Positions	3
Number of Rows	1

Body Features

Connector Profile	Standard
Primary Product Color	Black



Contact Features

Mating Pin Diameter	.63 mm[.024 in]
Mating Square Post Dimension	.63 mm[.024 in]
PCB Contact Termination Area Plating Material Thickness	2.4 – 4 µm[94.488 – 157.48 µin]
Contact Shape & Form	Square
Contact Layout	Inline
Contact Protection Type	Closed Entry Housing
Contact Base Material	Phosphor Bronze
PCB Contact Termination Area Plating Material	Tin
Contact Mating Area Plating Material	Gold (Au)
Contact Type	Socket
Contact Current Rating (Max)	3 A

Termination Features

Rectangular Termination Post & Tail Width	.69 mm[.027 in]
Rectangular Termination Post & Tail Thickness	.2 mm[.008 in]
Termination Post & Tail Length	3.1 mm[.122 in]
Termination Method to PCB	Through Hole - Solder

Mechanical Attachment

PCB Mount Retention Type	Retention Solder Tails
PCB Mount Retention	With
Connector Mounting Type	Board Mount

Housing Features

Mating Entry Location	Top
Housing Material	Polyester - GF
Centerline (Pitch)	2.54 mm[.1 in]

Dimensions

PCB Thickness (Recommended)	1.6 mm[.063 in]
Connector Height	8.5 mm[.335 in]

Usage Conditions

Operating Temperature Range	-65 – 125 °C[-67 – 221 °F][-85 – 257 °F]
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Operation/Application

Solder Process Feature	Board Standoff
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Industry Standards

UL Flammability Rating	UL 94V-0
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Packaging Features

Packaging Quantity	240
Packaging Method	Carton

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2025 (247) Candidate List Declared Against: JAN 2025 (247) Does not contain REACH SVHC
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Wave solder capable to 265°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: <https://echa.europa.eu/guidance-documents/guidance-on-reach>

Compatible Parts



TE Part # 966306-3
MOD2 ST-LEI SMD 3P

TE Part # 966710-3
MODU II PIN HEADER, SGL ROW, SMD- 3 POS

TE Part # 826630-3
3P AMPMODU II STIFT LEI

TE Part # 826646-3
3P AMPMODU II STIFT LEI

TE Part # 826647-3
3P AMPMODU II STIFT LEI

TE Part # 1241150-3
3P MOD II BREAK AWAY HDR,SMD, BLISTER

TE Part # 826654-3
3P AMPMODU II STIFT LEI

TE Part # 826631-3
3P AMPMODU II STIFT LEI

TE Part # 826652-3
3P AMPMODU II STIFT LEI

TE Part # 826648-3
3P AMPMODU II STIFT LEI

TE Part # 826629-3
3P AMPMODU II

Also in the Series | AMPMODU HV-100/HV-190

Board-to-Board Headers & Receptacles(321)

PCB Headers & Receptacles(321)

Customers Also Bought

TE Part #1614350-2
RN 0603 10R 0.1% 10PPM CUT LENGTH

TE Part #2-215309-5
2X25P HV100 REC CON. TE, 8.5MM

TE Part #36925
TERMINAL,SOLIS R 2/0 1/2

TE Part #T4145415051-001
M12 R/A F PNLREAR STAMPED PIN B-CODE 5P



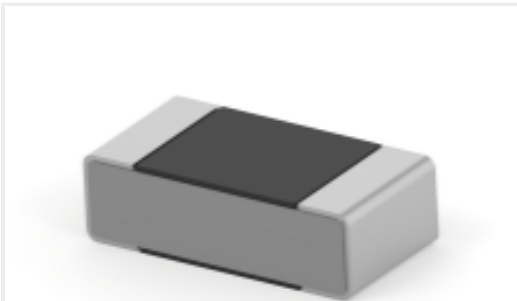
TE Part #130599P002
ES2000-NO.4-B7-0-27MM



TE Part #5-103976-5
4X6 MTE RCPT SR PLAIN .100CL



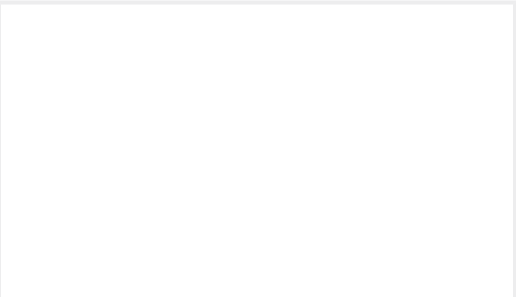
TE Part #36923
TERMINAL,SOLIS R 2/0 3/8



TE Part #7-1879128-8
RN 0402 1K0 0.1% 10PPM 5K RL



TE Part #1981568-1
MICRO USB, TYPE B,



TE Part #1825219-3
TT11DGPC104

Documents

Product Drawings
3P HV100 REC CON. TE, 8.5MM
English

CAD Files
3D PDF
3D
Customer View Model
ENG_CVM_CVM_215299-3_F.2d_dxf.zip
English
Customer View Model
ENG_CVM_CVM_215299-3_F.3d_igs.zip
English
Customer View Model
ENG_CVM_CVM_215299-3_F.3d_stp.zip
English

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Product Specifications
Product Specification
English